



SQ3000V2

Multi Function AOI, SPI & CMM

Optical Inspection & Metrology

www.nordson.com/TestInspect



Test & Inspection

Nordson Test & Inspection

Founded in 1954, Nordson Corporation is a market leading industrial technology company with annual revenues of over \$2.1 billion and more than 7,500 employees worldwide.

Nordson Test & Inspection offers its SMT & Semiconductor customers a robust product portfolio, including Acoustic, Optical and both Manual and Automated X-ray Inspection systems, X-ray Component Counting systems and Semiconductor measurement sensors. Nordson Test & Inspection is uniquely positioned to serve its customers with best-in-class precision technologies, passionate sales and support teams, global reach, and unmatched consultative applications expertise.

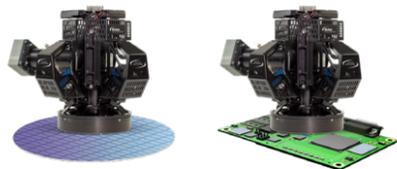


Exceptional support
from Nordson's worldwide network

AOI Products

Proprietary Advanced Technology

Optical Inspection & Metrology



WS Products

Improve Your Yields

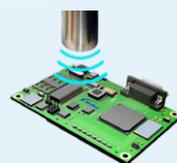
Semiconductor Metrology Sensors



AMI Products

Qualify Your Design

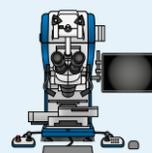
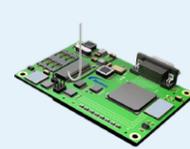
Acoustic Inspection



BT Products

Test Your Design

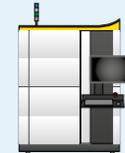
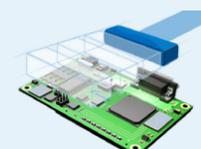
Bondtesters



AXI Products

High Speed High Flexibility

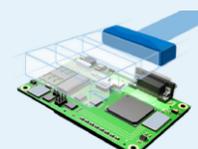
Automated X-ray Inspection



MXI Products

Making the Invisible, Visible

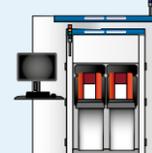
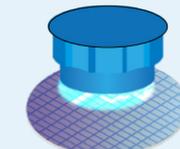
Manual X-ray Inspection



AXM Products

Measuring the Invisible

Automated X-ray Metrology



CC Products

Maximize Efficiency

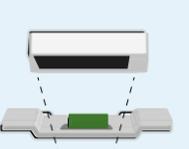
X-ray Component Counting



XT Products

High Speed High Resolution

X-ray Technologies



Multi Function Advantages

The SQ3000V2 is an all-in-one solution that's loaded with powerful tools that cover inspection and measurement for AOI, SPI and CMM applications.

For larger boards the SQ3000V2™ X offers support of large board capability of up to 710 x 610 mm board sizes.



Shorter Inspection Times



Unmatched Accuracy and Resolution with MRS Technology

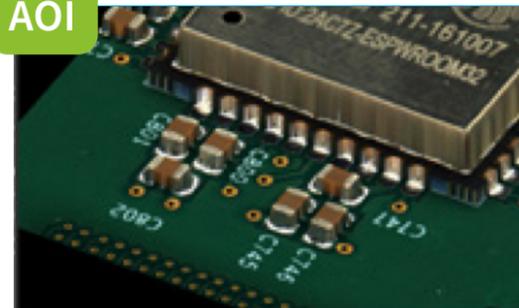


Versatility for Applications with High Quality Requirements

AOI, SPI, CMM IN-LINE

The SQ3000V2 all-in-one is capable of performing AOI, SPI and CMM in-line.

AOI

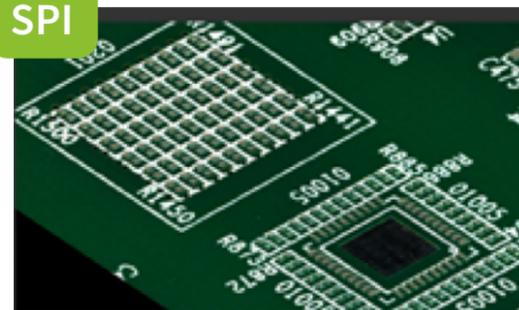


Automated Optical Inspection (AOI)

Achieve metrology-grade accuracy at production speed enabled by MRS technology.

Attain repeatable and reproducible measurements for SMT, semiconductor, microelectronics and metrology applications.

SPI

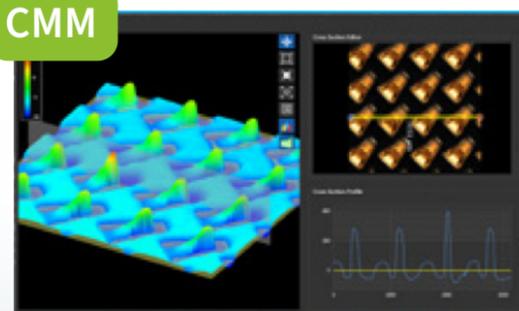


Solder Paste Inspection (SPI)

Richer SPI Experience with Closed Loop, Feedback - Feed Forward. Optimize printing process by proactively analyzing current trend data with the standalone SPI software and Nordson Print Optimizer.

Enable smarter and faster inspection that provides reduction in rework costs, minimizes scrap and optimizes print process.

CMM



Coordinate Measuring Machine (CMM)

SQ3000V2 utilizes Nordson CMM, a comprehensive software of coordinate measurement tools which provides highly accurate, 100% metrology-grade measurement on all critical points.

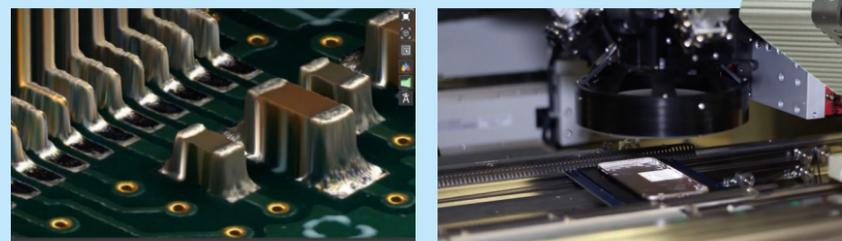
A fast and easy set-up can be performed with the world's first in-line CMM system for programming complex applications.

Multi-Reflection Suppression® (MRS®) Sensor Technology

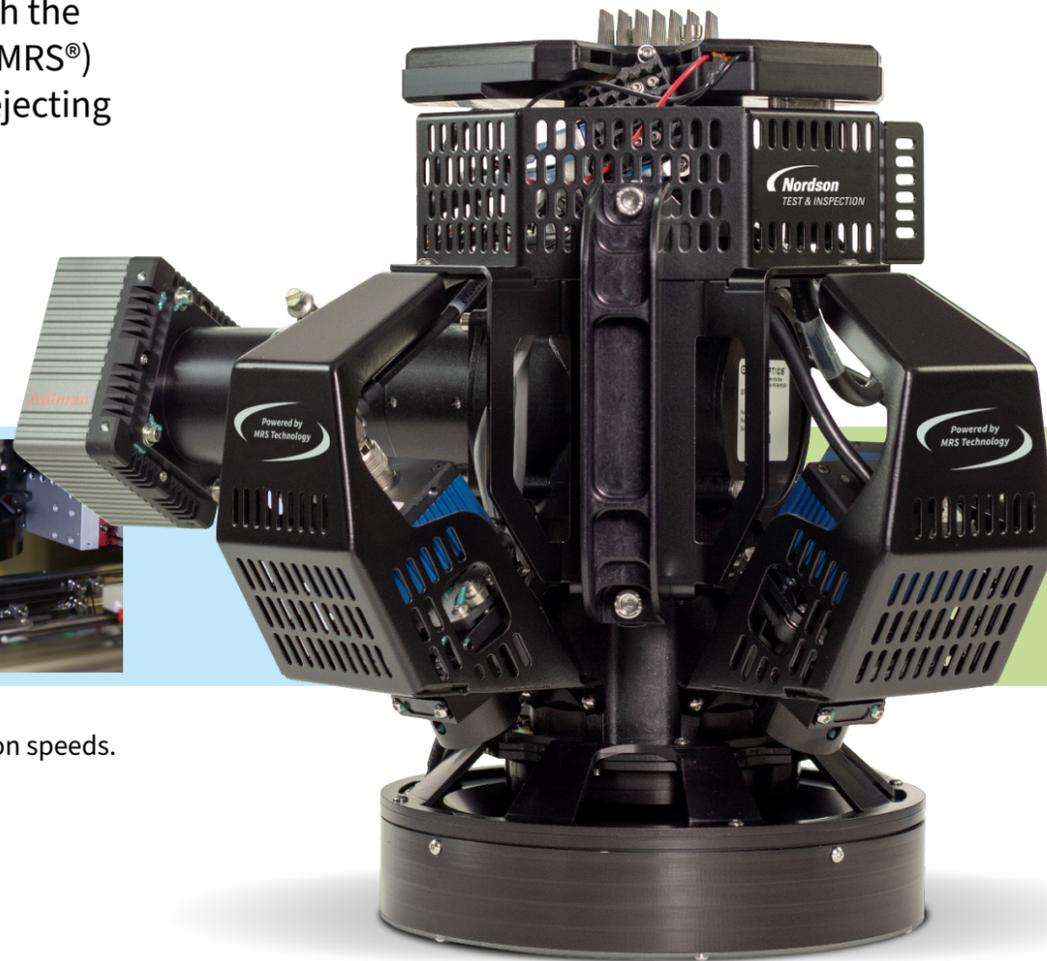
The SQ3000V2 offers unmatched accuracy with the revolutionary Multi-Reflection Suppression® (MRS®) technology by meticulously identifying and rejecting reflections caused by shiny components.

Reflection based distortions

MRS is designed to Inhibit reflection-based distortions from shiny and specular surfaces.



Enabling the highest possible inspection accuracy at production speeds.



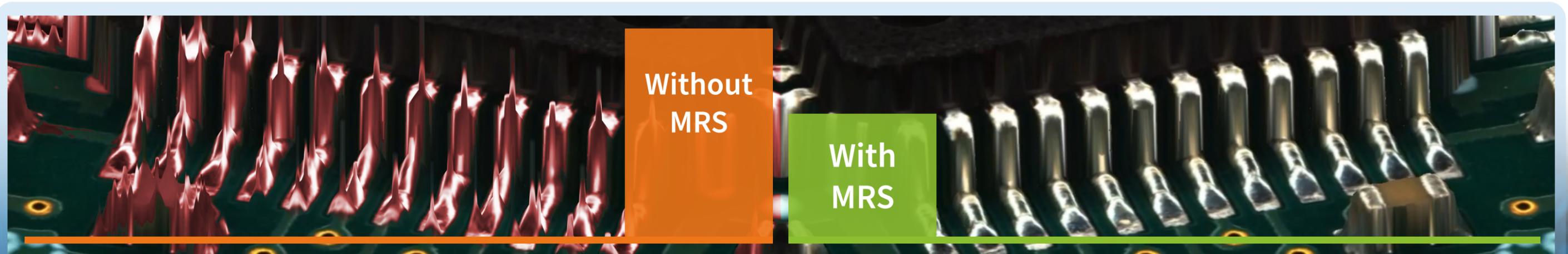
Nordson's MRS Sensor for SQ3000V2 3D AOI, SPI and CMM's breakthrough 3D sensing technology comprising four multi-view 3D sensors and a parallel projector delivering metrology grade accuracy at production speed.

Nordsons' unique sensor architecture simultaneously captures and transmits multiple images in parallel while proprietary 3D fusing algorithms merge the images together. The result is ultra-high quality 3D images, accurate to sub 10 µm at production speed.

MULTIPLE MRS SENSOR OPTIONS

Standard MRS Sensor	High Speed	High Resolution	Ultra High Resolution
---------------------	------------	-----------------	-----------------------

The Ultra-High Resolution MRS sensor enhances the SQ3000V2 platform, delivering superior inspection performance, ideally suited for the 0201 metric process and micro-electronic applications where an even greater degree of accuracy and inspection reliability is critical



Enable Smarter, Faster Inspection

The multi-award winning SQ3000V2 AOI software is a more powerful yet extremely simple software suite designed with an intuitive interface and multi-touch control with 3D image visualization tools.

Ultra-fast programming capabilities

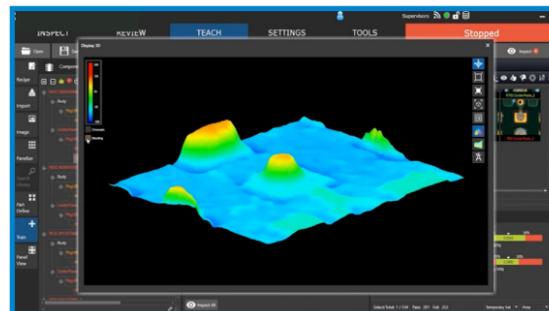
Bring the ease-of-use to a completely new level and significantly speed setup, simplify the process, reduce training efforts and minimize operator interaction – all saving time and cost.

Speed programming and performance with AI² (Autonomous Image Interpretation) technology for set-up in <13 minutes with a data-rich, pre-loaded library and automated scripts that collect and update models all on their own.

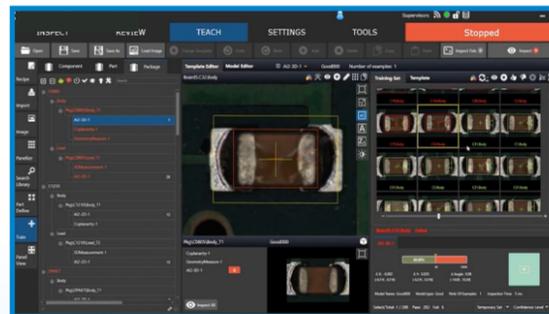
AI² - Enable smarter, faster inspection

Inspect the most comprehensive list of features and identify the widest variety of defects. AI² offers precise discrimination with just one panel inspection making it the perfect solution for high-mix and high-volume applications.

AI² technology is all about keeping it simple - no parameters to adjust or algorithms to tune. You don't need to anticipate defects or pre-define variance either. AI² does it all for you. Powered by a data-rich, pre-loaded library and automated scripts that collect and update models all on their own.



AOI & SPI Inspection Measurement Tools - Detect even the most subtle defects, insufficient & excess solder, Solder Meniscus measurement. Additional tools include, Height, Volume, Area, XY Offset, Blob Analysis, Bridging & more.



Powerful 3D image visualization with ultra-fast programming capabilities that brings ease-of-use to a completely new level.

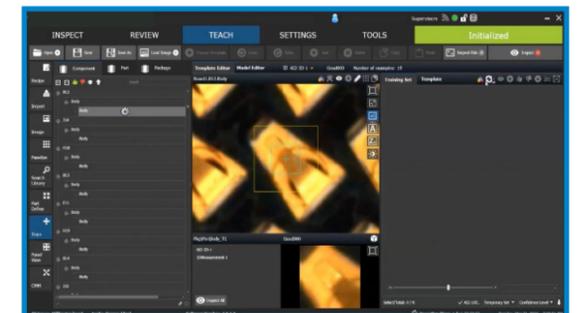
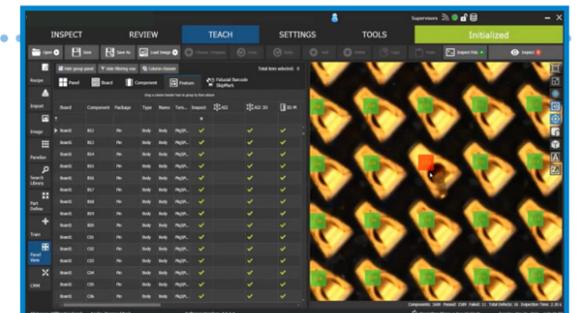
Faster, Highly Accurate CMM Suite

Nordson Software Solutions provide our customers and partners the best added-value possible for inspection and measurement in electronics manufacturing.

Nordson CMM

Nordson CMM software suite

Nordson CMM's comprehensive software suite of coordinate measurement tools, provides highly accurate, 100% metrology-grade measurement on all critical points much faster than a traditional CMM, including coplanarity, distance, height and datum X, Y to name a few. A fast and easy set-up can be performed with the world's first in-line CMM system for programming complex applications as compared to slow, engineering resource-intensive set-ups that typically requires multiple adjustments with traditional coordinate measurement machines (CMMs).



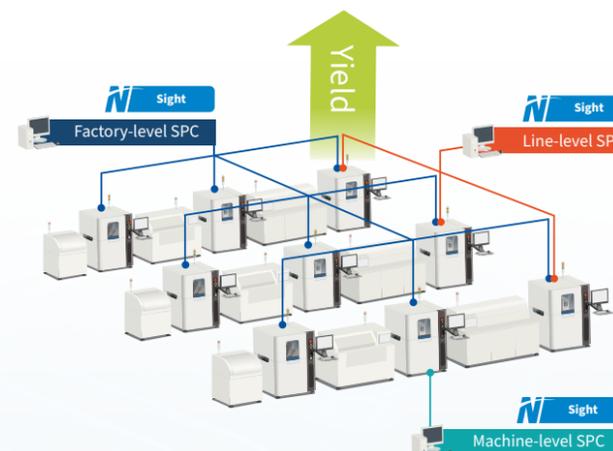
Measure critical points faster than traditional measurement systems.

Nordson Sight

Nordson Sight - Fast, scalable SPC software solution

Nordson Sight offers full-fledged machine to factory level SPC capability with powerful historical analysis and reporting tools. The software delivers complete traceability for effective process verification and yield improvement.

Nordson Sight is designed for simple set-up and intuitive use, while simultaneously delivering scalability, fast charting, and an extremely compact database size.



High End Applications

The SQ3000V2 offers unmatched accuracy with the revolutionary Multi-Reflection Suppression (MRS) technology. Effective suppression of multiple reflections is critical for accurate measurement, making MRS an ideal technology solution for a wide range of applications including those with very high quality requirements.

The SQ3000V2 inspection and measurement capabilities include:



Advanced Packaging

Fine pitch component • BGA solder ball • Diameter uniformity • BGA coplanarity.



LED

Backlight • Five point & solder paste • Pad gap • Warpage coplanarity • Illumination Intensity • Adhesive squeeze out • Dye chip out.



Advanced Socket Metrology

Pin • True position • Dispensed material • Dispensed patterns.



Solder Paste

Tight area • Off water bridging • Jet print paste • Type 4 paste.



Semiconductor

Highly reflective dye • Wirebond • Ribbons • Ball bond • Wirebonding • Wedgebond • Wirebond loop height • Cornerfill / Underfill.



SMT Electronics

Microelectronics • Various electronics applications.



Medical

Tighter tolerance • Higher demand for accuracy • Life critical • Small components, Micro electronics • Conformal coating.



Defense

Component verification • Counterfeit part detection • High map • Point cloud output • Adhesive & epoxy.



Aerospace

Metal module cavities • Substrate • Critical • Highly reflective material • Wire bond • Ribbon.



Automotive

Tuning forks • Connector • True position for key features • True position for key component • High precision placement • Smaller Modules • Critical pin.



Inspection Capabilities	Standard MRS Sensor	High-Speed MRS Sensor	High-Resolution MRS Sensor	Ultra-High Resolution MRS Sensor
Inspection Speed	40 cm ² /sec (2D+3D)	50 cm ² /sec (2D+3D)	20 cm ² /sec (2D+3D)	15 cm ² /sec (2D+3D)
Minimum Component Size	0402 mm (01005 in.)		0201 mm (008004 in.)	
PCB Size	Minimum: 50 x 50 mm (2 x 2 in.); Maximum: 510 x 510 mm (20 x 20 in.)			
Component Height Clearance	50 mm			
Board Edge Clearance	Top: 2.5 mm (0.10 in.); Bottom: 3 mm (0.12 in.)			
PCB Thickness	0.3 to 5.0 mm			
Component Types Inspected	Standard SMT (chips, J-lead, gull-wing, BGA, etc.), through-hole, odd-form, clips, connectors, header pins, and more			
Component Defects	Missing, polarity, tombstone, billboard, flipped, wrong part, gross body and lead damage, and more			
Solder Joint and Other Defects	Gold finger contamination, excess solder, insufficient solder, bridging, through-hole pins			
3D Measurement Inspection	Lifted Lead, package coplanarity, polarity dimple and chamfer identification			
Measurement Gage R&R	<10% @ ±3σ (±80 μm process tolerance)			
Z Height Accuracy	1 μm on certification target			
Z Measurement Range	6 mm at spec, 24 mm capability		3 mm at spec, 8 mm capability	

CMM Capabilities				
Accuracy XY / Z	6 μm / 2 μm		5 μm / 2 μm	
Resolution XY / Z	10 μm / 0.5 μm		7 μm / 0.5 μm	
Maximum Weight	3 kg / 5 kg (Option)			
Min./ Max. Feature Height	Min. 50 μm ; Max. 24mm		Min. 50 μm ; Max. 8mm	
Carrier Thickness	0.3 - 5 mm (10 mm Option)			
Coordinate Measurement Capability	Line / Distance / X,Y / Mid Line, Inter Point / Regression Shifted, Datum X,Y / LSF X,Y Offset, X,Y Offset / Value / Location / List of X,Y Values, Height / Local Height / Regression / Radius, Coplanarity/ Distance to plane / 2nd Order fitting, Difference / Absolute / 2sqrt / VC, Max / Min / Ave / Sigma / Plus / Minus / Multiple			

Vision System & Technology				
Imagers	Multi-3D sensors			
Resolution	Sub 10 μm		7 μm	
Field of View (FOV)	36 x 30 mm	36 x 36 mm	26 x 26 mm	21 x 21 mm
Maximum Inspection Area	508 x 503 mm (20 x 19.8 in.)			
Image Processing	Autonomous Image Interpretation (AI ²) Technology, Coplanarity and Lead Measurement			
Programming Time	<13 minutes (for established libraries)			
CAD Import	Any column-separated text file with ref designator, XY, Angle, Part no info; Valor process preparation			

System Specifications	
Machine Interface	SMEMA, RS232 and Ethernet
Power Requirements	100-120 VAC or 220-240 VAC, 50/60 hz, 10-15 amps
Compressed Air Requirements	5.6 Kg/cm ² to 7.0 Kg/cm ² (80 to 100 psi @ 4 cfm)
System Dimensions	107 x 129 x 145 cm (W x D x H)
Weight	965 kg (2127 lbs.)

Options	
	Barcode Reader, Rework station, Nordson Sight SPC Software, Alignment Target, Programming Software: ePM-SPI/AOI & GC-Power-Place, Offline Defect Review.

For more information, speak with your Nordson representative or contact your Nordson regional office

Nordson Test & Inspection Europe, SEA, Africa
ti-sales-eu@nordson.com

Nordson Test & Inspection Americas
ti-sales-us@nordson.com

Nordson Test & Inspection China
ti-sales-cn@nordson.com

Nordson Test & Inspection Japan
ti-sales-jp@nordson.com

Nordson Test & Inspection Singapore
ti-sales-sg@nordson.com

Nordson Test & Inspection Taiwan
ti-sales-tw@nordson.com

Nordson Test & Inspection Korea
ti-sales-korea@nordson.com



Specifications subject to change without prior notice.
Copyright © Nordson 2025. Other products and company names mentioned are trademarks or trade names of their respective companies. Nordson Test & Inspection products are patent protected and covered by the patent listed at www.nordson.com.
BR-SQ3000V2-MUL 14/02/2025